



SILICON 900

THERMAL PASTE

PRODUCT FEATURES:

- High efficiency with a thermal conductivity of 12.8 W/m·K and an optimal density of 2.8 g/cm³.
- Safety and durability thanks to non-conductive properties and corrosion resistance.
- Even easier application with an included spatula and a pre-saturated grease cleaner.

PRODUCT SPECIFICATION:

Thermal conductivity	12,8 W/mK
Relative density	2,8 g/cm ³
Environment temperature	from -50 up to 250 °C
Included Accessories	Applicator, Wet cleaning wipe
Colour	Gray
Weight	2 g

